DATASHEET

HyperX Badge Pack - 8 Bit Magnetic Badges

ACCENTUATE YOUR AESTHETIC!

Looking for a simple way to add some extra style and personalization to your keyboard? A pack of HyperX Magnetic Badges is the perfect way to accent the aesthetics of your HyperX Alloy Rise keyboard. HyperX Magnetic Badges are super easy to apply or swap out, and they're a budget-friendly way to subtly update your keyboard's look and put a smile on your face. Each of the 3 individual themed packs (Cute, 8-bit, and Abstract) includes 4 magnetic, hard enamel badges.



Key features

Accentuate your aesthetic

It's time to accessorize and personalize! Give your keyboard a new look without having to install new keycaps with these elegant enamel badges.

Multiple themes available

Choose from 3 different themes: Cute, 8-bit, and Abstract. Each themed pack contains a set of 4 badges.

Vibrant and durable

These magnetic, hard enamel badges will keep your keyboard looking good for a long time.

Built for HyperX Alloy Rise keyboards

Whether you're rocking the full-sized Alloy Rise or the Alloy Rise 75, these badges will click right into place.







Product Names	**Product name**: HyperX Badge Pack - 8 Bit Magnetic Badges
Product Numbers	**Product number**: 85U19AA
Appearance	**Frame shape**: Layout: 8-bit.
Compatibility	**Compatibility statement**: Alloy Rise and Alloy Rise 75
Dimensions	**Height (metric)**: 14.9 mm ; **Width (metric)**: 20.1 mm ; **Depth (metric)**: 1.2 mm
Minimum order quantity	Minimum Purchase Quantity corresponds to the Carton's Units Quantity.
What is in the box	4 HyperX Magnetic Badges, Quick Start Guide.
Manufacturer Warranty	2 years

MESSAGING FOOTNOTES

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